Chip Monolithic Ceramic Capacitors (Medium Voltage)

Large Capacitance and High Allowable Ripple Current GR3 Series

Features

- 1. This series can provide higher capacitance value under DC-Bias condition, compare with previous X7R char.
- 2. Improve the performance of ripple-resistance compared with X7R char.
- 3. Reduce acoustic noise.
- 4. High reliability for board bending stress
- 5. Sn-plated external electrodes provide good soldering, and other types with reflow soldering only.
- 6. Use the GR321/331 types with flow or reflow soldering, and other types with reflow soldering only.

Applications

- 1. DC smoothing & EMI filiter for LED Lighting.
- 2. For PFC circuit in the swiching power supplies, AC adaptor.
- 3. DC-DC converter for general electronic equipment.

Do not use these products in any Automotive Power train or Safety equipment incliding Battery chargers for Electric Vehicles and Plug-in Hybrids. Only Murata products clearly stipulated as "for Automotive use" can be used for automobile appliations such as Power train and Safety equipment.



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Part Number	Dimensions (mm)									
Fait Number	L	w	Т	е	g min.					
GR321A	2.0±0.2	1.25±0.2	1.0+0,-0.3		0.7					
GR321B	2.010.2	1.2510.2	1.25±0.2	0.3 min.	0.7					
GR331A	3.2±0.2	1.6±0.2 2.5±0.2	1.0+0,-0.3							
GR331B			1.25+0,-0.3		1.2					
GR331C			1.6±0.2							
GR332Q	3.2±0.3		1.5+0,-0.3							
GR332D	3.2±0.3		2.0+0,-0.3							
GR343Q	4.5±0.4		1.5+0,-0.3		2.2					
GR343D	4.5±0.4	3.2±0.3	2.0+0,-0.3		2.2					
GR355D	5.7±0.4	5.0±0.4	2.0+0,-0.3	1	3.2					
GR355X	5.7±0.4	5.0±0.4	2.7+0,-0.3		3.2					

Part Number	Rated Voltage	TC Code (Standard)	Capacitance	Length L (mm)	Width W (mm)	Thickness T max. (mm)	Electrode g min.	Electrode e
GR321AD72E103KW01D	250Vdc	X7T (EIA)	10000pF±10%	2	1.25	1	0.7mm	0.3mm min.
GR321AD72E153KW01D	250Vdc	X7T (EIA)	15000pF±10%	2	1.25	1	0.7mm	0.3mm min.
GR321BD72E223KW03L	250Vdc	X7T (EIA)	22000pF±10%	2	1.25	1.45	0.7mm	0.3mm min.
GR331AD72E333KW01D	250Vdc	X7T (EIA)	33000pF±10%	3.2	1.6	1	1.2mm	0.3mm min.
GR331BD72E473KW01L	250Vdc	X7T (EIA)	47000pF±10%	3.2	1.6	1.25	1.2mm	0.3mm min.
GR331CD72E683KW03L	250Vdc	X7T (EIA)	68000pF±10%	3.2	1.6	1.8	1.2mm	0.3mm min.
GR332QD72E104KW01L	250Vdc	X7T (EIA)	0.10µF±10%	3.2	2.5	1.5	1.2mm	0.3mm min.
GR332DD72E154KW01L	250Vdc	X7T (EIA)	0.15µF±10%	3.2	2.5	2	1.2mm	0.3mm min.
GR343QD72E224KW01L	250Vdc	X7T (EIA)	0.22µF±10%	4.5	3.2	1.5	2.2mm	0.3mm min.
GR343DD72E334KW01L	250Vdc	X7T (EIA)	0.33µF±10%	4.5	3.2	2	2.2mm	0.3mm min.
GR355DD72E474KW01L	250Vdc	X7T (EIA)	0.47µF±10%	5.7	5.0	2	3.2mm	0.3mm min.
GR355DD72E684KW01L	250Vdc	X7T (EIA)	0.68µF±10%	5.7	5.0	2	3.2mm	0.3mm min.
GR355XD72E105KW05L	250Vdc	X7T (EIA)	1.0µF±10%	5.7	5.0	2.7	3.2mm	0.3mm min.
GR331AD72W103KW01D	450Vdc	X7T (EIA)	10000pF±10%	3.2	1.6	1	1.2mm	0.3mm min.
GR331AD72W153KW01D	450Vdc	X7T (EIA)	15000pF±10%	3.2	1.6	1	1.2mm	0.3mm min.
GR331BD72W223KW01L	450Vdc	X7T (EIA)	22000pF±10%	3.2	1.6	1.25	1.2mm	0.3mm min.
GR331BD72W333KW01L	450Vdc	X7T (EIA)	33000pF±10%	3.2	1.6	1.25	1.2mm	0.3mm min.
GR331CD72W473KW03L	450Vdc	X7T (EIA)	47000pF±10%	3.2	1.6	1.8	1.2mm	0.3mm min.
GR332DD72W683KW01L	450Vdc	X7T (EIA)	68000pF±10%	3.2	2.5	2	1.2mm	0.3mm min.
GR332DD72W104KW01L	450Vdc	X7T (EIA)	0.10µF±10%	3.2	2.5	2	1.2mm	0.3mm min.
GR343DD72W154KW01L	450Vdc	X7T (EIA)	0.15µF±10%	4.5	3.2	2	2.2mm	0.3mm min.
GR355DD72W224KW01L	450Vdc	X7T (EIA)	0.22µF±10%	5.7	5.0	2	3.2mm	0.3mm min.
GR355DD72W334KW01L	450Vdc	X7T (EIA)	0.33µF±10%	5.7	5.0	2	3.2mm	0.3mm min.
GR355DD72W474KW01L	450Vdc	X7T (EIA)	0.47µF±10%	5.7	5.0	2	3.2mm	0.3mm min.
GR355XD72W564KW05L	450Vdc	X7T (EIA)	0.56µF±10%	5.7	5.0	2.7	3.2mm	0.3mm min.

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ANote • Please read rating and ACAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
 This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

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Part Number	Rated Voltage	TC Code (Standard)	Capacitance	Length L (mm)	Width W (mm)	Thickness T max. (mm)	Electrode g min.	Electrode e
GR331BD72J103KW01L	630Vdc	X7T (EIA)	10000pF±10%	3.2	1.6	1.25	1.2mm	0.3mm min.
GR331CD72J153KW03L	630Vdc	X7T (EIA)	15000pF±10%	3.2	1.6	1.8	1.2mm	0.3mm min.
GR332QD72J223KW01L	630Vdc	X7T (EIA)	22000pF±10%	3.2	2.5	1.5	1.2mm	0.3mm min.
GR332DD72J333KW01L	630Vdc	X7T (EIA)	33000pF±10%	3.2	2.5	2	1.2mm	0.3mm min.
GR332DD72J473KW01L	630Vdc	X7T (EIA)	47000pF±10%	3.2	2.5	2	1.2mm	0.3mm min.
GR343DD72J683KW01L	630Vdc	X7T (EIA)	68000pF±10%	4.5	3.2	2	2.2mm	0.3mm min.
GR355DD72J104KW01L	630Vdc	X7T (EIA)	0.1µF±10%	5.7	5.0	2	3.2mm	0.3mm min.
GR355DD72J154KW01L	630Vdc	X7T (EIA)	0.15µF±10%	5.7	5.0	2	3.2mm	0.3mm min.
GR355XD72J224KW05L	630Vdc	X7T (EIA)	0.22µF±10%	5.7	5.0	2.7	3.2mm	0.3mm min.
GR355XD72J274KW05L	630Vdc	X7T (EIA)	0.27µF±10%	5.7	5.0	2.7	3.2mm	0.3mm min.

Only for Applications GRM/GRJ/GR3 Series

AC250V Type GA2 Series

Safety Standard Certified GA3 Series

Product Information

GR3 Series Specifications and Test Methods

No.	Ite	em	Specifications	Test Method			
1	Operating Temperatu	ire Range	-55 to +125°C	-			
2	Appearan	ice	No defects or abnormalities	Visual inspection			
3	Dimensio	ns	Within the specified dimensions	Using calipers and micrometers			
4	Dielectric Strength		No defects or abnormalities	No failure should be observed when voltage in Table is applied between the terminations for 1 to 5 sec., provided the charge/discharge current is less than 50mA. Rated Voltage Test Voltage DC250V 200% of the rated voltage DC450V 150% of the rated voltage DC630V 120% of the rated voltage			
5	Insulation F (I.R.)	Resistance	More than 10,000M Ω or 100M Ω • μF (Whichever is smaller)	The insulation resistance should be measured with DC500±50V (DC250±25V in case of rated voltage: DC250V, DC450V) and within 60±5 sec. of charging.			
6	Capacitar	nce	Within the specified tolerance				
7	Dissipatio Factor (D.		0.01 max.	The capacitance/D.F. should be measured at a frequency of 1±0.2kHz and a voltage of AC1±0.2V(r.m.s.).			
8	8 Capacitance Temperature Characteristics		Cap. Change Within ±웈중% (Temp. Range: –55 to +125°C) No removal of the terminations or other defect should occur.	The capacitance measurement should be made at each step specified in the Table. Step Temperature (°C) 1 25 ± 2 2 Min. Operating Temp. ± 3 3 25 ± 2 4 Max. Operating Temp. ± 2 5 25 ± 2 • Pretreatment Perform a heat treatment at $150\pm^{\circ}_{Po}^{\circ}$ C for 60 ± 5 min. and then let sit for 24 ± 2 hrs. at room condition.* Solder the capacitor to the testing jig (glass epoxy board) shown in Fig. 1. Then apply 10N force in the direction of the arrow. The soldering should be done using the reflow method and should be conducted with care so that the soldering is uniform and free of defects such as heat shock. Image: 10N, 10±1s			
		Appearance	No defects or abnormalities	Glass Epoxy Board Fig. 1 Solder the capacitor to the test jig (glass epoxy board).			
		Capacitance	Within the specified tolerance	The capacitor should be subjected to a simple harmonic motion			
10	Vibration Resistance	D.F.	0.01 max.	having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz, should be traversed in approximately 1 min. This motion should be applied for a period of 2 hrs. in each of 3 mutually perpendicular directions (total of 6 hrs.).			

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* "Room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

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GR3 Series Specifications and Test Methods

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11 Deflection		L×W (mm) 2.0×1.25 3.2×1.6 3.2×2.5 4.5×3.2 5.7×5.0	a 1.2 2.2 2.2 3.5 4.5	b 100 Fig. 2 Dimense b 4.0 5.0 5.0 7.0 8.0	04.5 ↓ t:1.6 ion (mm) C 1.65 2.0 2.9 3.7 5.6	d 1.0	in Fig. 2. Then apply a The soldering should be cor	pacitor to the testing jig (glass force in the direction shown in should be done using the ref aducted with care so that the s fects such as heat shock. $\begin{array}{c} 20 & \text{Pressurizer}\\ \text{Fressurize}\\ \text{Fressurize}\\ \text{Flexure}\\ 45 & \text{Fig. 3} \end{array}$	n Fig. 3. low method and soldering is uniform		
12		Solderability of Termination 75% of the terminations are to be soldered evenly and continuously. Immerse in solder solution for 2±0.5 Immersing speed: 25±2.5mm/s Temp. of solder: 245±5°C Lead Free 235±5°C H60A or 1				902) (25% rosin in weight pro older solution for 2±0.5 sec. eed: 25±2.5mm/s	portion). r (Sn-3.0Ag-0.5Cu				
		Appearance Capacitance Change	No marking defe	ects				Preheat the capacitor at 120 to 150°C* for 1 min. Immerse the capacitor in solder solution at 260±5°C for 10±1 sec. Let sit at room condition* for 24±2 hrs., then measure.			
		D.F.	0.01 max.					 Immersing speed: 25±2.5mm/s Pretreatment 			
13	Resistance to Soldering	I.R.	More than 10,00	0MQ or 1	00MQ • µF	Whichever	is smaller)	Perform a he	eat treatment at 150±1°°C for ±2 hrs. at room condition.*	60±5 min. and the	
		Dielectric Strength Appearance	In accordance w No marking defe		0.4			Step Temperature Time 1 100 to 120°C 1 min. 2 170 to 200°C 1 min. Fix the capacitor to the supporting jig (glass epoxy board) show in Fig. 4.			
		Capacitance Change	Within ±7.5%					Perform the 5 cycles according to the 4 heat treatments listed the following table.			
		D.F.	0.01 max.					Let sit for 24±2 hrs. at room condition,* then measure.			
		I.R.	More than 10,00	0MΩ or 1	00MΩ•μF	Whichever	is smaller)	Step 1	Temperature (°C) Min. Operating Temp. ⁺⁰ /-3	Time (min.) 30±3	
	Temperature							2 3 4	Room Temp. Room Temp. Max. Operating Temp. Room Temp.	2 to 3 30±3 2 to 3	
Cycle					•Pretreatment Perform a heat treatment at 150±1%°C for 60±5 min. and the let sit for 24±2 hrs. at room condition.*						
		Appearance	No marking defe	ects							
	Humidity	Capacitance Change	Within ±12.5%					for 500 ⁺²⁴ / ₀ hrs	tor sit at 40±2°C and relative I s. let sit for 24±2 hrs. at room co	2	
15	(Steady	D.F.	0.02 max.					measure.			
	State)			smaller)	•Pretreatment Perform a heat treatment at 150±18°C for 60±5 min. and the						
	,	I.n.	More than 1,000	1002 or 10	10122 pr (11	Dielectric Strength In accordance with item No.4				60+5 min and the	

* "Room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

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GR3 Series Specifications and Test Methods

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No.	Item		Specifications	Test Method					
		Appearance No marking defects		Apply voltage as Table for 1,000 ^{±48} hrs. at maximum operating temperature ±3°C. Remove and let sit for 24±2 hrs. a					
		Change	Within ±12.5%		room condition,* then measure.				
		D.F.	0.02 max.	Rated Voltage DC250V	Applied Voltage 150% of the rated voltage				
16	6 Life	I.R.	More than 1,000M Ω or $10M\Omega$ • μF (Whichever is smaller)	DC450V DC630V	130% of the rated voltage 120% of the rated voltage				
		Dielectric Strength	In accordance with item No.4	The charge/discharge current is less than 50mA. •Pretreatment Apply test voltage for 60±5 min. at test temperature. Remove and let sit for 24±2 hrs. at room condition.*					
		Appearance	No marking defects						
		Capacitance Change	Within ±12.5%	95% for 500 ^{±2} 6hrs.	Apply the rated voltage at $40\pm2^{\circ}$ C and relative humidity of 90 95% for $500\pm^{2}$ % hrs. Remove and let sit for 24±2 hrs. at room condition,* then				
17	Humidity Loading	D.F.	0.02 max.	measure.					
	Localing	I.R.	More than 1,000M Ω or 10M Ω • μF (Whichever is smaller)	Pretreatment Apply test voltage for	 •Pretreatment Apply test voltage for 60±5 min. at test temperature. Remove and let sit for 24±2 hrs. at room condition.* 				
		Dielectric Strength	In accordance with item No.4						

* "Room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

Only for Applications GRM/GRJ/GR3 Series

